

FAN5354

3MHz, 3A Synchronous Buck Regulator

Features

- 3MHz Fixed-Frequency Operation
- Best-in-Class Load Transient
- 3A Output Current Capability
- 2.7V to 5.5V Input Voltage Range
- Adjustable Output Voltage: 0.8 to $V_{IN} \cdot 0.9$
- PFM Mode for High Efficiency in Light Load (Forced PWM Available on MODE Pin)
- Minimum PFM Frequency Avoids Audible Noise
- $270\mu\text{A}$ Typical Quiescent Current in PFM Mode
- External Frequency Synchronization
- Low Ripple Light-Load PFM Mode with Forced PWM Control
- Power Good Output
- Internal Soft-Start
- Input Under-Voltage Lockout (UVLO)
- Thermal Shutdown and Overload Protection
- 12-Lead 3x3.5mm MLP

Applications

- Set-Top Box
- Hard Disk Drive
- Communications Cards
- DSP Power

Description

The FAN5354 is a step-down switching voltage regulator that delivers an adjustable output from an input voltage supply of 2.7V to 5.5V. Using a proprietary architecture with synchronous rectification, the FAN5354 is capable of delivering 3A at over 85% efficiency, while maintaining a very high efficiency of over 80% at load currents as low as 2mA. The regulator operates at a nominal fixed frequency of 3MHz, which reduces the value of the external components to 470nH for the output inductor and 10μF for the output capacitor. Additional output capacitance can be added to improve regulation during load transients without affecting stability and inductance up to 1.2μH may be used with additional output capacitance.

At moderate and light loads, pulse frequency modulation (PFM) is used to operate the device in power-save mode with a typical quiescent current of 270μA. Even with such a low quiescent current, the part exhibits excellent transient response during large load swings. At higher loads, the system automatically switches to fixed-frequency control, operating at 3MHz. In shutdown mode, the supply current drops below 1μA, reducing power consumption. PFM mode can be disabled if constant frequency is desired. To avoid audible noise, the regulator limits its minimum PFM frequency. The FAN5354 is available in 12-lead 3x3.5mm MLP package.

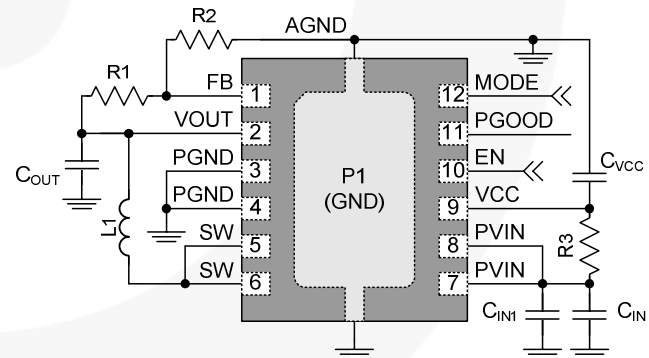


Figure 1. Typical Application

Ordering Information

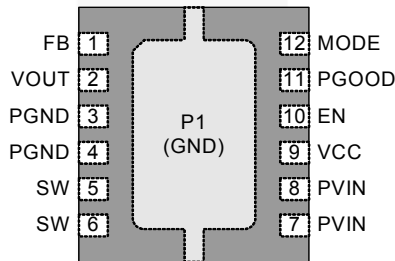
Part Number	Temperature Range	Package	Packing Method
FAN5354MPX	-40 to 85°C	MLP-12, 3x3.5mm	Tape and Reel

Table 1. Recommended External Components for 3A Maximum Load Current

Component	Description	Vendor	Parameter	Typ.	Units
L1	470nH Nominal	IHLP1616ABER47M01 (Vishay) SD12-R47-R (Coiltronics) VLC5020T-R47N (TDK) (TDK) LQH55PNR47NT0 (Murata)	L	0.47	μH
			DCR	20	$\text{m}\Omega$
C _{OUT}	2 Pieces 10 μF , 6.3V, X5R, 0805	GRM21BR60J106M (Murata) C2012X5R0J106M (TDK)	C	10.0	μF
C _{IN}	10 μF , 6.3V, X5R, 0805				
C _{IN1}	10nF, 25V, X7R, 0402	GRM155R71E103K (Murata) C1005X7R1E103K (TDK)	C	10	nF
C _{VCC}	4.7 μF , 6.3V, X5R, 0603	GRM188R60J475K (Murata) C1608X5R0J475K (TDK)	C	4.7	μF
R3 ⁽¹⁾	Resistor: 1 Ω 0402	Any	R	1	Ω

Note:

- R3 is optional and improves IC power supply noise rejection. See *Layout recommendations* for more information.

Pin Configuration**Figure 2. 12-Pin, 3x3.5mm MLP (Top View)****Pin Definitions**

Pin #	Name	Description
1	FB	FB. Connect to resistor divider. The IC regulates this pin to 0.8V.
2	VOUT	VOUT. Sense pin for VOUT. Connect to C _{OUT} .
3, 4	PGND	Power Ground. Low-side MOSFET is referenced to this pin. C _{IN} and C _{OUT} should be returned with a minimal path to these pins.
5, 6	SW	Switching Node. Connect to inductor.
P1	GND	Ground. All signals are referenced to this pin.
7, 8	PVIN	Power Input Voltage. Connect to input power source. Connect to C _{IN} with minimal path.
9	VCC	IC Bias Supply. Connect to input power source. Use a separate bypass capacitor CVCC from this pin to the P1 GND terminal between pins 1 and 12.
10	EN	Enable. The device is in shutdown mode when this pin is LOW. Do not leave this pin floating.
11	PGOOD	Power Good. This open-drain pin pulls LOW if the output falls out of regulation or is in soft-start.
12	MODE	MODE / Sync. A logic 0 allows the IC to automatically switch to PFM during light loads. When held HIGH, the IC stays in PWM mode. The regulator also synchronizes its switching frequency to the frequency provided on this pin. Do not leave this pin floating.

Note:

- P1 is the bottom heat-sink pad. Ground plane should flow through pins 3, 4, and P1 and can be extended through pin 11 if PGOOD's function is not required, and through pin 12 if MODE is to be grounded, to improve IC cooling.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Units	
V _{IN}	SW, PVIN, VCC Pins	IC Not Switching	-0.3	7.0	V
		IC Switching	-0.3	6.5	
	Other Pins	-0.3	V _{CC} + 0.3 ⁽³⁾	V	
V _{INOV_SLEW}	Maximum Slew Rate of VIN Above 6.5V when PWM is Switching		15	V/ms	
R _{PGOOD}	Pull-Up Resistance from PGOOD to VCC	1		KΩ	
ESD	Electrostatic Discharge Protection Level	Human Body Model per JESD22-A114	2		KV
		Charged Device Model per JESD22-C101	2		
T _J	Junction Temperature	-40	+150	°C	
T _{STG}	Storage Temperature	-65	+150	°C	
T _L	Lead Soldering Temperature, 10 Seconds		+260	°C	

Note:

3. Lesser of 7V or V_{CC}+0.3V.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Typ.	Max.	Units
V _{CC} , V _{IN}	Supply Voltage Range	2.7		5.5	V
V _{OUT}	Output Voltage Range	0.8		90% Duty Cycle	V
I _{OUT}	Output Current	0		3	A
L	Inductor		0.47		μH
C _{IN}	Input Capacitor		10		μF
C _{OUT}	Output Capacitor		20		μF
T _A	Operating Ambient Temperature	-40		+85	°C
T _J	Operating Junction Temperature	-40		+125	°C

Thermal Properties

Symbol	Parameter	Min.	Typ.	Max.	Units
θ _{JA}	Junction-to-Ambient Thermal Resistance ⁽⁴⁾		46		°C/W

Note:

4. Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 1s2p boards in accordance to JESD51- JEDEC standard. Special attention must be paid not to exceed junction temperature T_{J(max)} at a given ambient temperature T_A.

Electrical Characteristics

Minimum and maximum values are at $V_{IN}=2.7V$ to $5.5V$, $T_A=-40^{\circ}C$ to $+85^{\circ}C$, unless otherwise noted. Typical values are at $T_A=25^{\circ}C$, $V_{IN}=5V$.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
Power Supplies						
I_Q	Quiescent Current	$I_{LOAD}=0$, MODE=0		270		μA
		$I_{LOAD}=0$, MODE=1 (Forced PWM)		14		mA
I_{SD}	Shutdown Supply Current	EN=GND		0.1	3.0	μA
V_{UVLO}	Under-Voltage Lockout Threshold	V_{IN} Rising		2.83	2.95	V
		V_{IN} Falling	2.10	2.30	2.40	V
V_{UVHYS}	Under-Voltage Lockout Hysteresis			530		mV
Logic Pins						
V_{IH}	HIGH-Level Input Voltage		1.05			V
V_{IL}	LOW-Level Input Voltage				0.4	V
V_{LHYS}	Logic Input Hysteresis Voltage			100		mV
I_{IN}	Input Bias Current	Input Tied to GND or V_{IN}		0.01	1.00	μA
I_{OUTL}	PGOOD Pull-Down Current	$V_{PGOOD}=0.4V$			1	mA
I_{OUTH}	PGOOD HIGH Leakage Current	$V_{PGOOD}=V_{IN}$		0.01	1.00	μA
V_{OUT} Regulation						
V_{REF}	Output Reference DC Accuracy Measured at FB Pin	$T_A=25^{\circ}C$	0.792	0.800	0.808	V
			0.788	0.800	0.812	V
V_{REG}	V_{OUT} DC Accuracy	At V_{OUT} Pin W.R.T. Calculated Value, $I_{LOAD}=500mA$	1.6		+1.6	%
$\frac{\Delta V_{OUT}}{\Delta I_{LOAD}}$	Load Regulation	$I_{OUT(DC)}=1$ to 3A		-0.03		%/A
$\frac{\Delta V_{OUT}}{\Delta V_{IN}}$	Line Regulation	$2.7V \leq V_{IN} \leq 5.5V$, $I_{OUT(DC)}=1.5A$		0.01		%/V
	Transient Response	I_{LOAD} Step 0.1A to 1.5A, $t_r=t_f=100ns$, $V_{OUT}=1.2V$		± 40		mV
Power Switch and Protection						
$R_{DS(ON)P}$	P-Channel MOSFET On Resistance			60		m Ω
$R_{DS(ON)N}$	N-Channel MOSFET On Resistance			40		m Ω
I_{LIMPK}	P-MOS Peak Current Limit		3.75	4.55	5.50	A
T_{LIMIT}	Thermal Shutdown			150		$^{\circ}C$
T_{HYS}	Thermal Shutdown Hysteresis			20		$^{\circ}C$
V_{SDWN}	Input OVP Shutdown	Rising Threshold		6.2		V
		Falling Threshold	5.50	5.85		V
Frequency Control						
f_{SW}	Oscillator Frequency		2.7	3.0	3.3	MHz
f_{SYNC}	MODE Pin Synchronization Range	External Square-Wave, 30% to 70% Duty Cycle	2.7	3.0	3.3	MHz
$f_{PFM(MIN)}$	Minimum PFM Frequency	$T_A = 25^{\circ}C$, $V_{IN} = 5.0V$	17	26	36	kHz
Soft-Start						
t_{SS}	Regulator Enable to Regulated V_{OUT}	$R_{LOAD} \geq 5\Omega$, to $V_{OUT}=1.2V$		210	250	μs
		$R_{LOAD} \geq 5\Omega$, to $V_{OUT}=1.8V$		340	420	μs
V_{SLEW}	Soft-Start V_{REF} Slew Rate			10		V/ms

Typical Characteristics

Unless otherwise specified, $V_{IN}=5V$, $V_{OUT}=1.2V$, circuit of Figure 1, and components per Table 1.

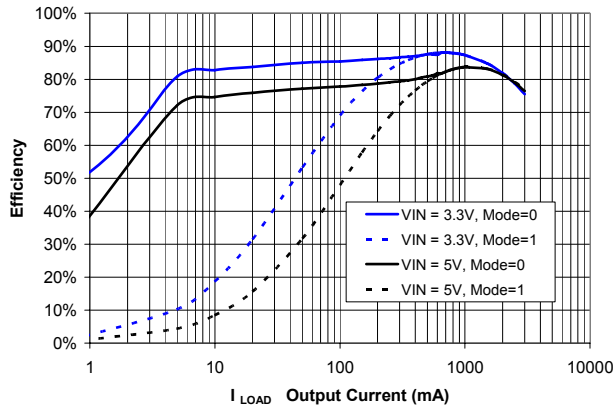


Figure 3. Efficiency vs. I_{LOAD} at $V_{OUT}=1.2V$

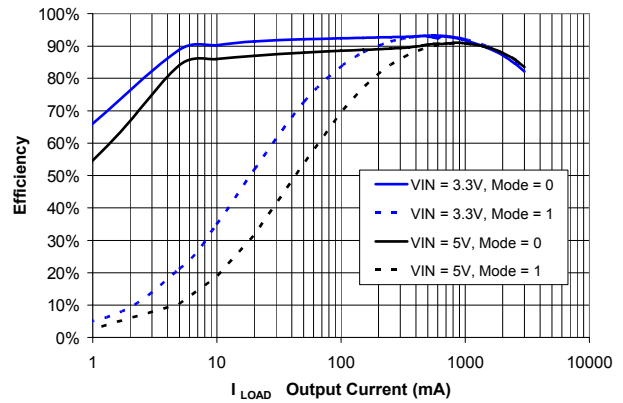


Figure 4. Efficiency vs. I_{LOAD} at $V_{OUT}=1.8V$

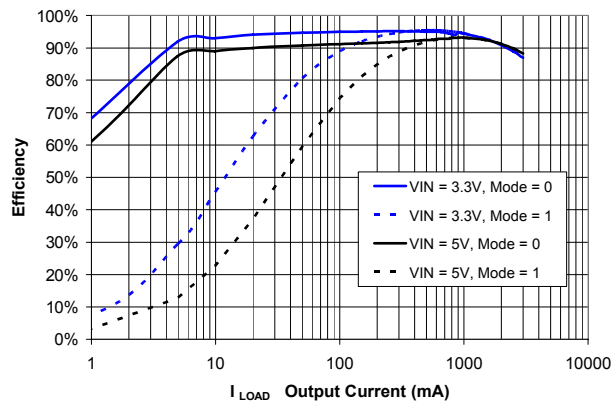


Figure 5. Efficiency vs. I_{LOAD} at $V_{OUT}=2.5V$

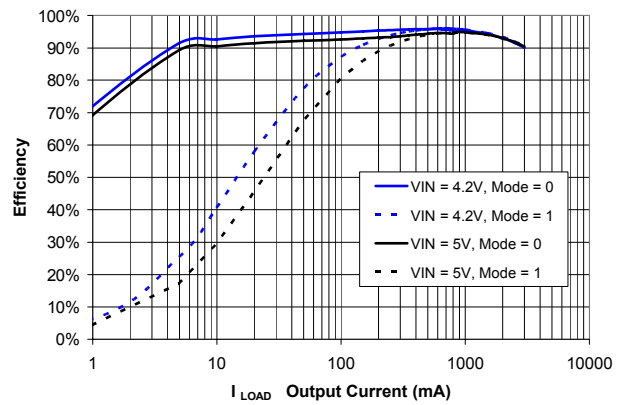


Figure 6. Efficiency vs. I_{LOAD} at $V_{OUT}=3.3V$

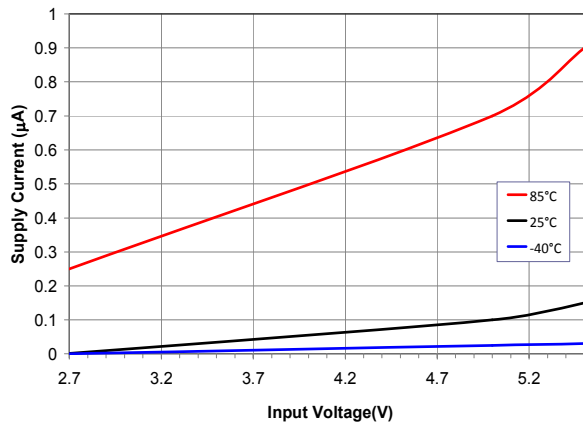


Figure 7. Shutdown Supply Current vs V_{IN} , $EN=0$

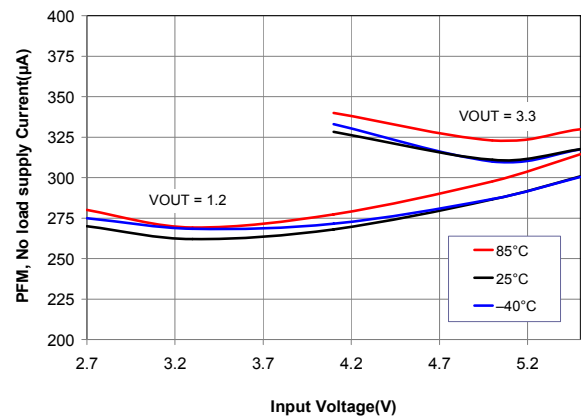


Figure 8. Quiescent Current in PFM vs. V_{IN} , No Load

Typical Characteristics

Unless otherwise specified, $V_{IN}=5V$, $V_{OUT}=1.2V$, circuit of Figure 1, and components per Table 1.

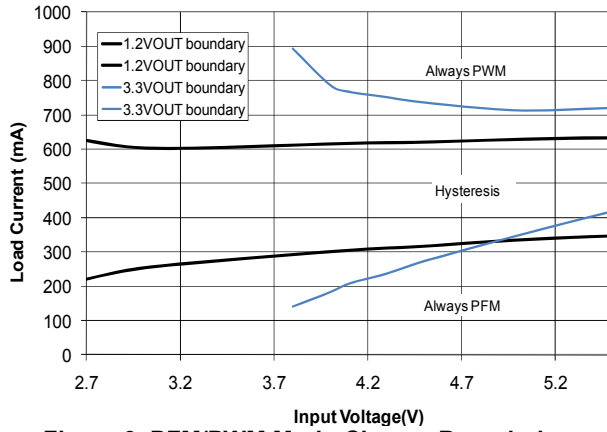


Figure 9. PFM/PWM Mode-Change Boundaries

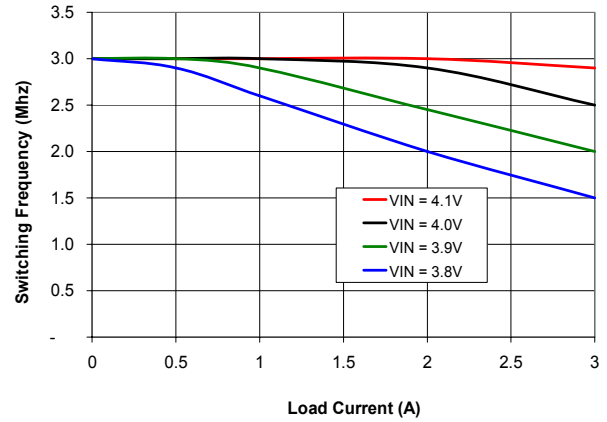


Figure 10. Effect of t_{OFF} Minimum on Reducing Switching Frequency at Large Duty Cycles, $V_{OUT}=3.3V$

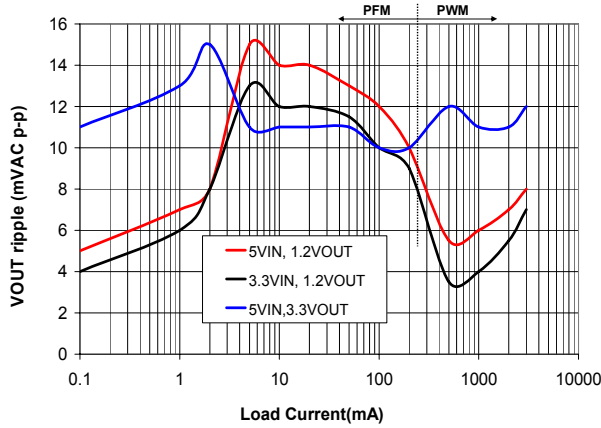


Figure 11. Output Voltage Ripple vs. Load Current
(See explanation on page 12)

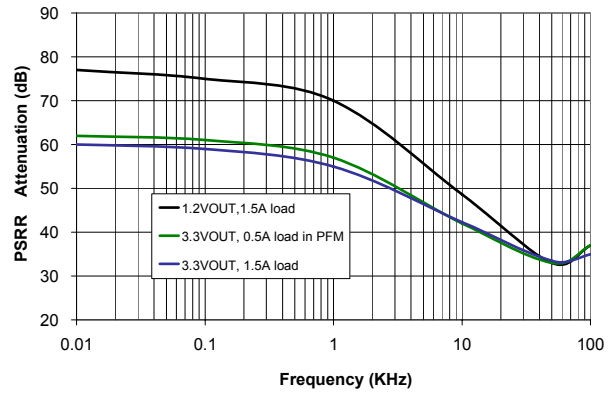


Figure 12. Power Supply Rejection Ratio (PSRR)

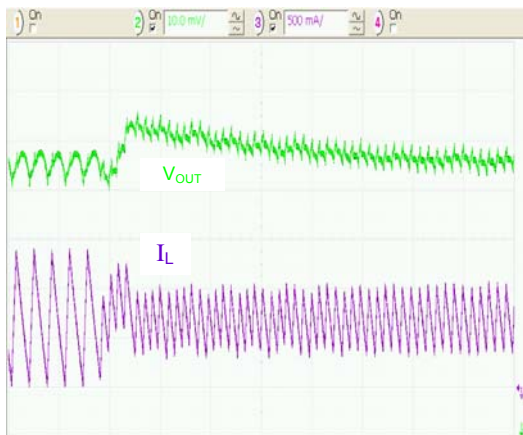


Figure 13. PFM-to-PWM Mode Transition, Slowly Increasing Load Current, $2\mu s/div$.

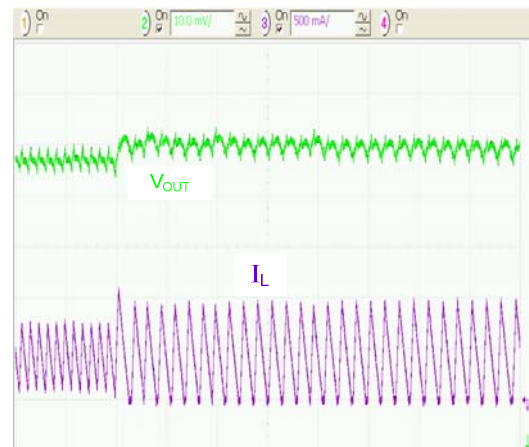


Figure 14 PWM-to-PFM Mode Transition, Slowly Decreasing Load Current, $2\mu s/div$.

Typical Characteristics

Unless otherwise specified, $V_{IN}=5V$, $V_{OUT}=1.2V$, circuit of Figure 1, and components per Table 1.

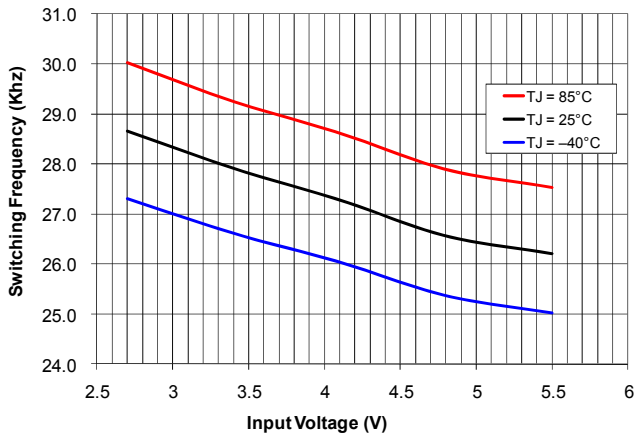


Figure 15. PFM frequency, $I_{LOAD} = 0$

Load Transient Response (Figure 16 – Figure 19). $I_{LOAD} t_R = t_F = 100ns$

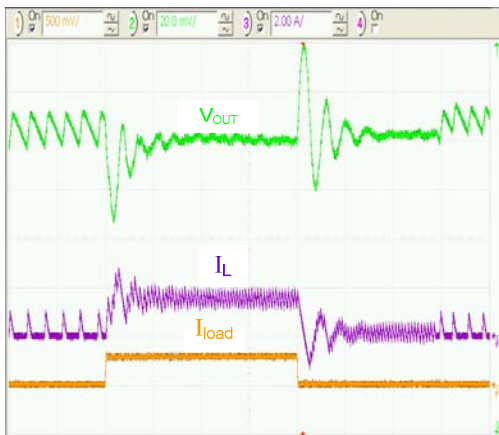


Figure 16. MODE=0, 100mA to 1.5A to 100mA, 5 μs /div.



Figure 17. 500mA to 3A to 500mA, 5 μs /div.

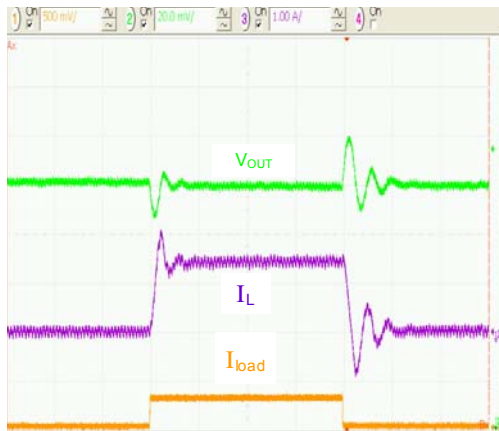


Figure 18. MODE=1, 100mA to 1.5A to 100mA, 5 μs /div.

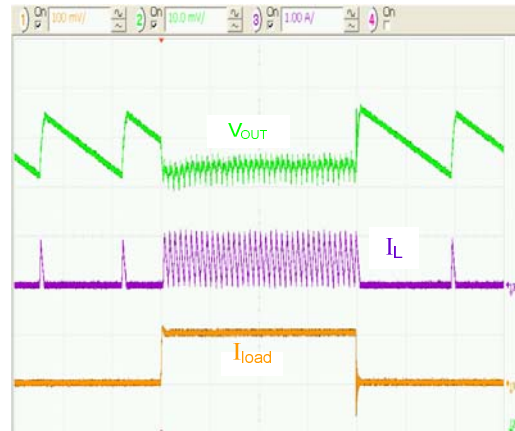


Figure 19. 24mA to 500mA to 24mA, MODE=0, 5 μs /div.

Typical Characteristics

Unless otherwise specified, $V_{IN}=5V$, $V_{OUT}=1.2V$, circuit of Figure 1, and components per Table 1.

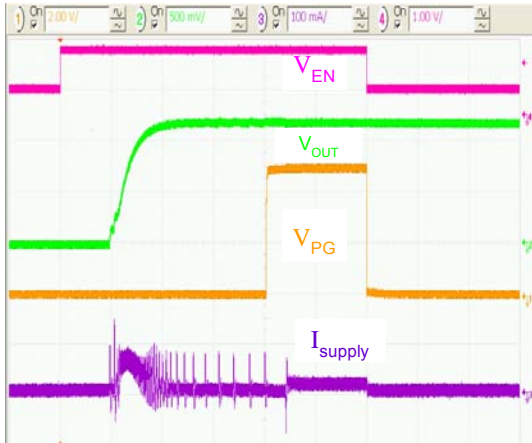


Figure 20. Soft-Start, EN Voltage Raised After $V_{IN}=5V$, $I_{LOAD}=0$, 100 μ s/div.



Figure 21. Soft-Start, EN Pin Tied to VCC $I_{LOAD}=0$, 1ms/div.

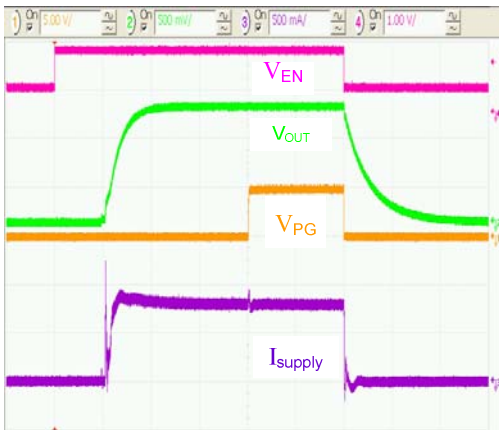


Figure 22. Soft-Start, EN Pin Raised After $V_{IN}=5V$ $R_{LOAD}=400m\Omega$, $C_{OUT}=100\mu F$, 100 μ s/div.



Figure 23. Soft-Start, EN Pin Tied to VCC $R_{LOAD}=400m\Omega$, $C_{OUT}=100\mu F$, 1ms/div.

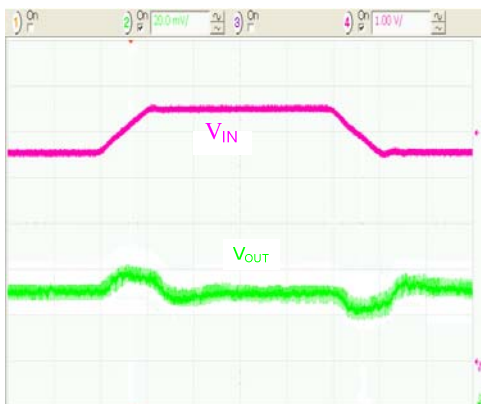


Figure 24. Line Transient Response in PWM Mode, 10 μ s/div.



Figure 25. Line Transient Response in PFM Mode, 10 μ s/div.

Typical Characteristics

Unless otherwise specified, $V_{IN}=5V$, $V_{OUT}=1.2V$, circuit of Figure 1, and components per Table 1.

Circuit Protection Response

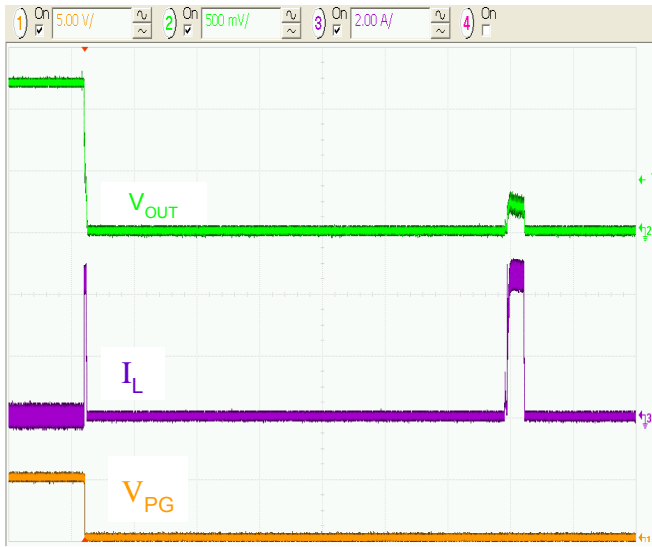


Figure 26. V_{OUT} to GND Short Circuit, 200μs/div.

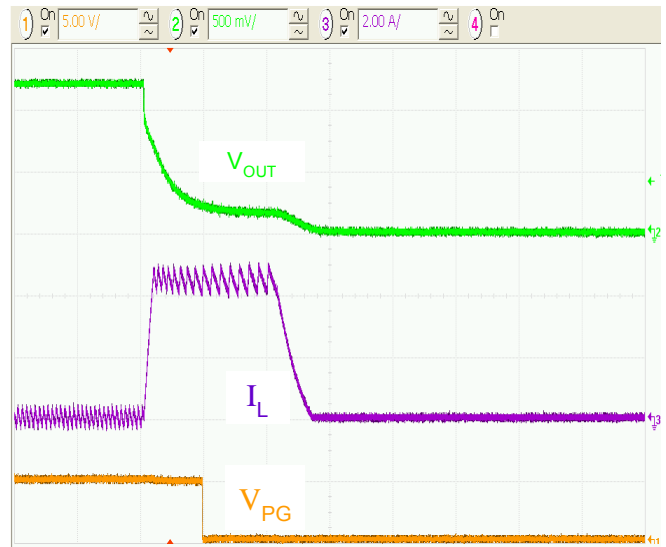


Figure 27. V_{OUT} to GND Short Circuit, 5μs/div.

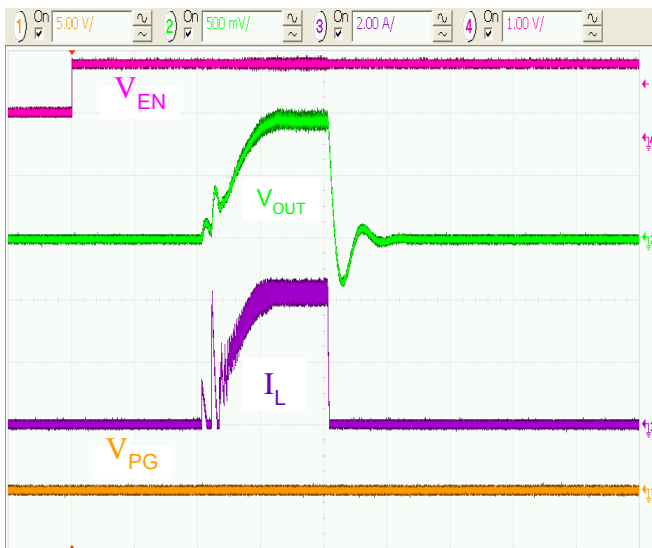


Figure 28. Over-Current at Startup, $R_{LOAD}=200m\Omega$, 50μs/div.

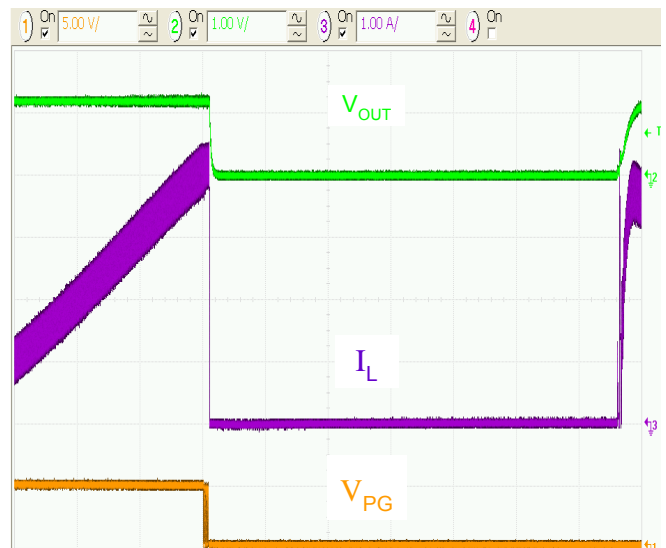


Figure 29. Progressive Overload, 200μs/div.

Operation Description

The FAN5354 is a step-down switching voltage regulator that delivers an adjustable output from an input voltage supply of 2.7V to 5.5V. Using a proprietary architecture with synchronous rectification, the FAN5354 is capable of delivering 3A at over 80% efficiency. The regulator operates at a nominal frequency of 3MHz at full load, which reduces the value of the external components to 470nH for the output inductor and 20μF for the output capacitor. High efficiency is maintained at light load with single-pulse PFM mode.

Control Scheme

The FAN5354 uses a proprietary non-linear, fixed-frequency PWM modulator to deliver a fast load transient response, while maintaining a constant switching frequency over a wide range of operating conditions. The regulator performance is independent of the output capacitor ESR, allowing for the use of ceramic output capacitors. Although this type of operation normally results in a switching frequency that varies with input voltage and load current, an internal frequency loop holds the switching frequency constant over a large range of input voltages and load currents.

For very light loads, the FAN5354 operates in discontinuous current (DCM) single-pulse PFM mode, which produces low output ripple compared with other PFM architectures. Transition between PWM and PFM is seamless, with a glitch of less than 18mV at V_{OUT} during the transition between DCM and CCM modes. The regulator limits minimum PFM frequency to typically 26KHz.

PFM mode can be disabled by holding the MODE pin HIGH. In addition, the IC synchronizes to the MODE pin frequency. When synchronizing to the MODE pin, PFM mode is disabled.

Setting the output voltage

The output voltage is set by the R1, R2, and V_{REF} (0.8V):

$$\frac{R1}{R2} = \frac{V_{OUT} - V_{REF}}{V_{REF}} \quad (1)$$

R1 must be set at or below 100KΩ; therefore:

$$R2 = \frac{R1 \cdot 0.8}{(V_{OUT} - 0.8)} \quad (2)$$

For example, for $V_{OUT}=1.2V$, $R1=100K\Omega$, $R2=200K\Omega$.

Enable and Soft Start

When the EN pin is LOW, the IC is shut down, all internal circuits are off, and the part draws very little current. Raising EN above its threshold voltage activates the part and starts the soft-start cycle. During soft-start, the modulator's internal reference is ramped slowly to minimize any large surge currents on the input and prevents any overshoot of the output voltage.

If large values of output capacitance are used, the regulator may fail to start. If V_{OUT} fails to achieve regulation within 320μs from the beginning of soft-start, the regulator shuts down and waits 1200μs before attempting a restart. If the regulator is at its current limit for more than about 60μs, the

regulator shuts down before restarting 1200μs later. This limits the C_{OUT} capacitance when a heavy load is applied during the startup. For a typical FAN5354 starting with a resistive load:

$$C_{OUT_{MAX}}(\mu F) \approx 400 - 100 \cdot I_{LOAD}(A)$$

$$\text{where } I_{LOAD} = \frac{V_{OUT}}{R_{LOAD}} \quad (3)$$

Synchronous rectification is inhibited during soft-start, allowing the IC to start into a pre-charged load.

MODE Pin – External Frequency Synchronization

Logic 1 on this pin forces the IC to stay in PWM mode. A logic 0 allows the IC to automatically switch to PFM during light loads. If the MODE pin is toggled, the converter synchronizes its switching frequency to four times the frequency on the mode pin (f_{MODE}).

The MODE pin is internally buffered with a Schmitt trigger, which allows the MODE pin to be driven with slow rise and fall times. An asymmetric duty cycle for frequency synchronization is permitted as long as the minimum time below $V_{IL(MAX)}$ or above $V_{IH(MAX)}$ is 100ns.

PGOOD Pin

The PGOOD pin is an open-drain that pin indicates that the IC is in regulation when its state is open. PGOOD pulls LOW under the following conditions:

1. The IC has operated in cycle-by-cycle current limit for eight or more consecutive PWM cycles.
2. The circuit is disabled, either after a fault occurs, or when EN is LOW.
3. The IC is performing a soft-start.

Under-Voltage Lockout

When EN is HIGH, the under-voltage lockout keeps the part from operating until the input supply voltage rises high enough to properly operate. This ensures no misbehavior of the regulator during startup or shutdown.

Input Over-Voltage Protection (OVP)

When V_{IN} exceeds V_{SDWN} (about 6.2V) the IC stops switching to protect the circuitry from internal spikes above 6.5V. An internal 40μs filter prevents the circuit from shutting down due to noise spikes. For the circuit to fully protect the internal circuitry, the V_{IN} slew rate above 6.2V must be limited to no more than 15V/ms when the IC is switching.

The IC protects itself if V_{IN} overshoots to 7V during initial power-up as long as the V_{IN} transition from 0 to 7V occurs in less than 10μs (10% to 90%).

Current Limiting

A heavy load or short circuit on the output causes the current in the inductor to increase until a maximum current threshold is reached in the high-side switch. Upon reaching this point,

the high-side switch turns off, preventing high currents from causing damage. 16 consecutive PWM cycles in current limit cause the regulator to shut down and stay off for about 1200µs before attempting a restart.

In the event of a short circuit, the soft-start circuit attempts to restart and produces an over-current fault after about 50µs, which results in a duty cycle of less than 10%, providing current into a short circuit.

Thermal Shutdown

When the die temperature increases, due to a high load condition and/or a high ambient temperature, the output switching is disabled until the temperature on the die has fallen sufficiently. The junction temperature at which the thermal shutdown activates is nominally 150°C with a 20°C hysteresis.

Minimum Off-Time Effect on Switching Frequency

$t_{ON(MIN)}$ and $t_{OFF(MIN)}$ are both 45ns. This imposes constraints on the maximum $\frac{V_{OUT}}{V_{IN}}$ that the FAN5354 can provide, while still maintaining a fixed switching frequency in PWM mode. While regulation is unaffected, the switching frequency will drop when the regulator cannot provide sufficient duty cycle at 3 MHz to maintain regulation.

The calculation for switching frequency is given below

$$f_{SW} = \min\left(\frac{1}{t_{SW(MAX)}}, \frac{1}{333.3ns}\right)$$

where

$$t_{SW(MAX)} = 45ns \cdot \left(1 + \frac{V_{OUT} + I_{OUT} \cdot R_{OFF}}{V_{IN} - I_{OUT} \cdot R_{ON} - V_{OUT}}\right) \quad (4)$$

$$R_{OFF} = R_{DS(ON)_N} + DCR_L$$

$$R_{ON} = R_{DS(ON)_P} + DCR_L$$

Application Information

Selecting the Inductor

The output inductor must meet both the required inductance and the energy handling capability of the application. The inductor value affects the average current limit, the output voltage ripple, and the efficiency.

The ripple current (ΔI) of the regulator is:

$$\Delta I \approx \frac{V_{OUT}}{V_{IN}} \cdot \left(\frac{V_{IN} - V_{OUT}}{L \cdot f_{SW}}\right) \quad (5)$$

The maximum average load current, $I_{MAX(Load)}$ is related to the peak current limit, $I_{LIM(PK)}$, by the ripple current as:

$$I_{MAX(Load)} = I_{LIM(PK)} - \frac{\Delta I}{2} \quad (6)$$

The FAN5354 is optimized for operation with $L=470nH$, but is stable with inductances up to 1.2µH (nominal). The inductor should be rated to maintain at least 80% of its value

at $I_{LIM(PK)}$. Failure to do so lowers the amount of DC current the IC can deliver.

Efficiency is affected by the inductor DCR and inductance value. Decreasing the inductor value for a given physical size typically decreases the DCR; but since ΔI increases, the RMS current increases, as do core and skin-effect losses.

$$I_{RMS} = \sqrt{I_{OUT(DC)}^2 + \frac{\Delta I^2}{12}} \quad (7)$$

The increased RMS current produces higher losses through the $R_{DS(ON)}$ of the IC MOSFETs as well as the inductor ESR.

Increasing the inductor value produces lower RMS currents, but degrades transient response. For a given physical inductor size, increased inductance usually results in an inductor with lower saturation current.

Table 2 shows the effects of inductance higher or lower than the recommended 470nH on regulator performance.

Table 2. Effects of Increasing the Inductor Value (from 470nH Recommended) on Regulator Performance

$I_{MAX(Load)}$	ΔV_{OUT} (EQ. 8)	Transient Response
Increase	Decrease	Degraded

Inductor Current Rating

The FAN5354's current limit circuit can allow a peak current of 5.5A to flow through L1 under worst-case conditions. If it is possible for the load to draw that much continuous current, the inductor should be capable of sustaining that current or failing in a safe manner.

For space-constrained applications, a lower current rating for L1 can be used. The FAN5354 may still protect these inductors in the event of a short circuit, but may not be able to protect the inductor from failure if the load is able to draw higher currents than the DC rating of the inductor.

Output Capacitor and V_{OUT} Ripple

Note:

Table 1 suggests 0805 capacitors, but 0603 capacitors may be used if space is at a premium. Due to voltage effects, the 0603 capacitors have a lower in-circuit capacitance than the 0805 package, which can degrade transient response and output ripple.

Increasing C_{OUT} has no effect on loop stability and can therefore be increased to reduce output voltage ripple or to improve transient response. Output voltage ripple, ΔV_{OUT} , is:

$$\Delta V_{OUT} = \Delta I \cdot \left(\frac{1}{8 \cdot C_{OUT} \cdot f_{SW}} + ESR\right) \quad (8)$$

where C_{OUT} is the effective output capacitance. The capacitance of C_{OUT} decreases at higher output voltages, which results in higher ΔV_{OUT} .

Physical Dimensions

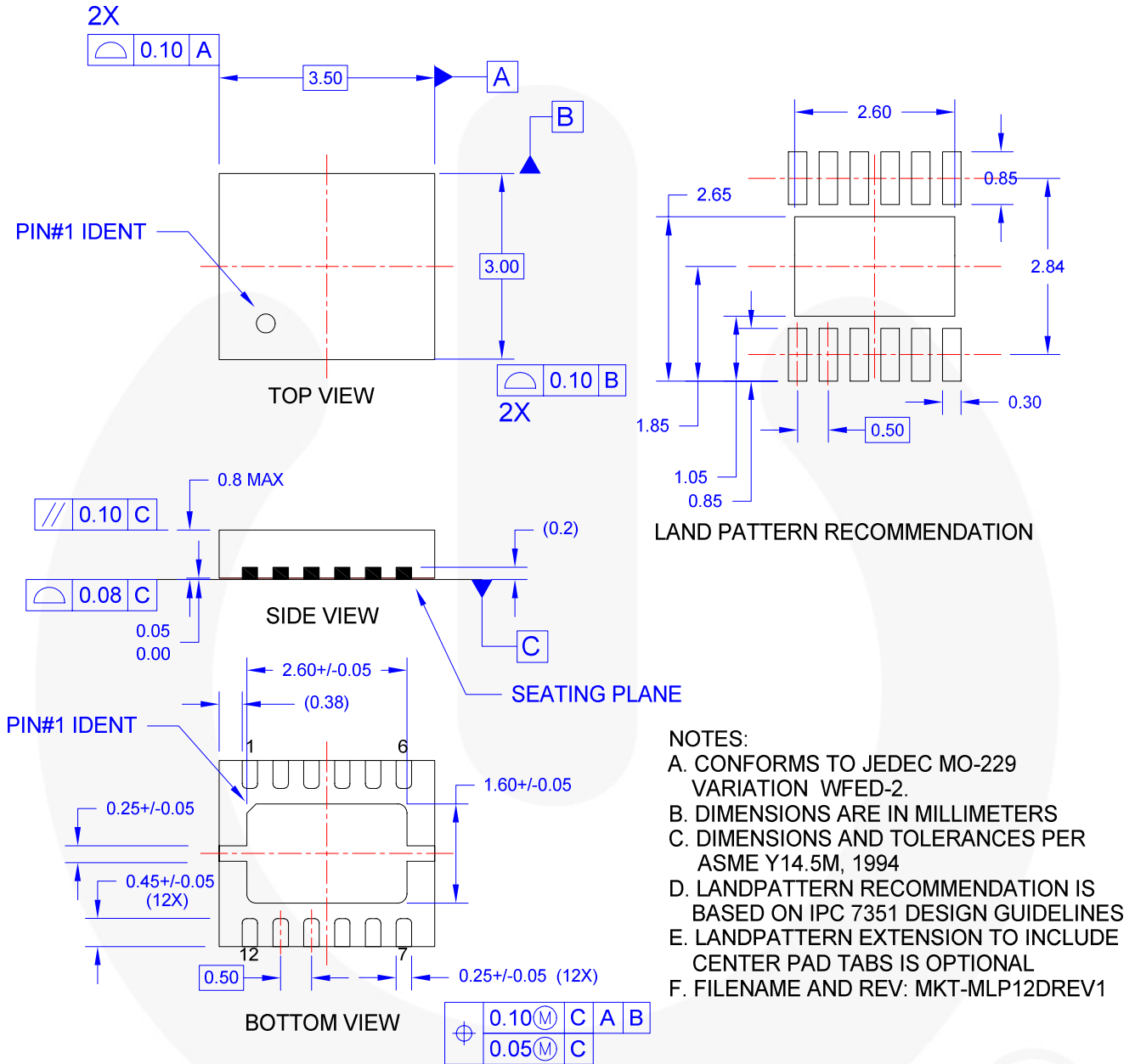


Figure 31. 12-lead 3 x 3.5mm MLP

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